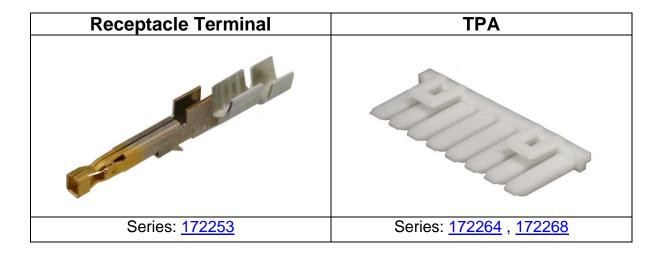


ULTRA-FIT

WIRE-TO-BOARD CONNECTOR SYSTEM

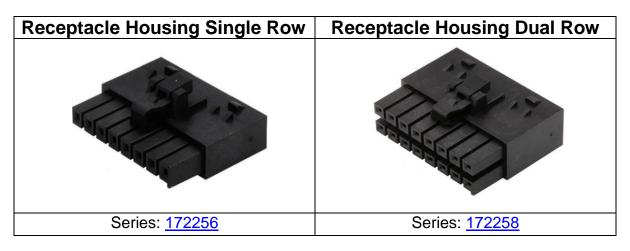


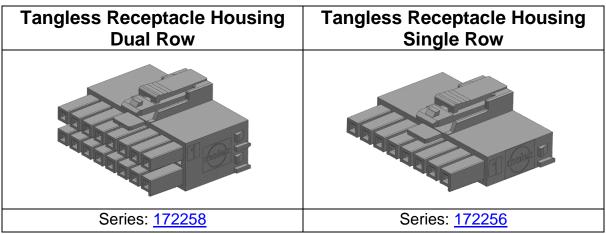
Tangless Receptacle Terminal	Tangless TPA
Series: <u>172253</u>	Series: <u>172264</u>



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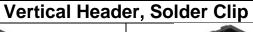






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Right Angle Header



Series: <u>172316</u>



Series: <u>172310</u>

Right Angle Header, Solder Clip



Series: 172316



Series: 172310

MOLEX ULTRA-FIT WEB PAGE

ECR/ECN INFORMATION:

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FOR ULTRA-FIT CONNECTOR SYSTEM

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PS-172323-0001

EC No: 636692

DATE: 04/29/2020

CREATED / REVISED BY:

TITLE:

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CHECKED BY:

JONNY.ZHENG

APPROVED BY:

ANSON.YIN



1.0	SCOPE	<u>5</u>
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4.0	ELECTRICAL PERFORMANCE RATINGS 4.1 Voltage 4.2 Applicable Wires 4.3 Maximum Current Rating 4.4 Temperature 4.5 Durability 4.6 Glow Wire	7 7 7 7 7 8 8 9
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1.0 SCOPE

This Product Specification covers Ultra-Fit 3.50 mm pitch wire to board connector systems with gold and tin plating. Receptacles are terminated with 22 to 16 AWG wire using crimp technology.

2.0 PRODUCT DESCRIPTION

2.1 PRODUCT NAME AND SERIES NUMBER (S)

Table 1 – WIRE-TO-BOARD					
Description	Series Number				
Receptacle Crimp Terminal	<u>172253</u>				
Receptacle Housing, Single Row	<u>172256</u>				
Receptacle Housing, Dual Row	<u>172258</u>				
TPA	<u>172264, 172268</u>				
Vertical Header Single Row, Kinked Pins	<u>172286</u>				
Vertical Header Single Row, Solder Clips	<u>172287</u>				
Vertical Header Dual Row, Kinked Pins	<u>172298</u>				
Vertical Header Dual Row, Solder Clips	<u>172299</u>				
Right Angle Header Single Row, Solder Clips	<u>172310</u>				
Right Angle Header Dual Row, Solder Clips	<u>172316</u>				

2.2 DIMENSIONS, MATERIALS, PLATING AND MARKINGS

Dimensions & Plating: See individual sales drawings. Material: RoHS compliant materials.

2.3 SAFETY AGENCY APPROVALS

2.3.1 UL File Number: E29179

UL (fully loaded) NON-current interruption	Current interruption per UL1977
14 Amps @ 600V (16 AWG wire)	14 Amps @ 48V AC/DC (16 AWG wire)

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2.3.2 IEC License Number per IEC / EN 61984: TBD

IEC (fully loaded)
NON-current interruption



2.3.3 C US File Number*: 70022376 (LR19980)

CSA approval meets following standards/test procedures:

* "C" and "US" mark adjacent to CSA signifies that the product has been evaluated to the applicable CSA and ANSI/UL standards, for use in Canada and US respectively.

CSA (single circuit) NON-current interruption

14 Amps @ 400V (16 AWG wire)

3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS

3.1 MOLEX DOCUMENTS

See series specific sales drawings and the other sections of this specifications for the necessary referenced documents and specifications.

Ultra-Fit Test Summary TS-172323-0001

Ultra-Fit Application Specification AS-172323-0001

Ultra-Fit Application Tooling Specification (Hand Crimp Tool) ATS-6382753HM

Ultra-Fit Application Tooling Specification (Insertion and Extractor Tool) ATS-011030016

Ultra-Fit Application Tooling Specification (Fine Adjust Applicator) ATS-639041600

Molex Quality Crimping Handbook Order No. 63800-0029

Molex Solderability Specification SMES-152

Molex Heat Resistance Specification AS-40000-5013

Molex Moisture Technical Advisory AS-45499-001

Molex Package Handling Specification 454990100-PK

3.2 INDUSTRY DOCUMENTS

EIA-364-1000.01 UL-60950-1 UL-1977 CSA STD. C22.2 NO. 182.3-M1987 IEC / EN 61984 USCAR-2 REV.6

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DATE: 04/29/2020

CONNECTOR SYSTEM

CREATED / REVISED BY: CHECKED BY: APPROVED BY:

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4.0 ELECTRICAL PERFORMANCE RATINGS

4.1 VOLTAGE*

600 Volts AC (RMS) or 600 Volts DC max.

* This connector voltage meets the connector level provided by the safety agency. For application voltage requirements per UL-60950 or other standards, the creepage & clearance also needs to be determined based upon pads/traces on the PCB.

4.2 APPLICABLE WIRES

Maximum Insulation Diameter and	Stranded copper 16 AWG: 2.39mm MAXIMUM Stranded copper 18 AWG: 2.03mm MAXIMUM Stranded copper 20 AWG: 1.78mm MAXIMUM
Applicable Wire Gauges	Stranded copper 22 AWG: 1.57mm MAXIMUM

4.3 MAXIMUM CURRENT RATING

Current rating is application dependent and may be affected by the wire rating such as listed in UL-60950-1. Each application should be evaluated by the end user for compliance to specific safety agency requirements. The ratings listed in the chart below are per Molex test method based on a 30°C maximum temperature rise over ambient temperature and are provided as a guideline. Appropriate de-rating is required based on circuit size, ambient temperature, copper trace size on the PCB, gross heating from adjacent modules/components and other factors that influence connector performance. Wire size, insulation thickness, stranding, tin coated or bare copper, wire length & crimp quality are other factors that influence current rating.

Wire to Board Current Rating (Amp Max.) (Tested with TIN plated terminals)														
Connector fully loaded with all circuits powered														
AWG Wire	G Wire Circuit Size (Single Row) Circuit Size (Dual Row)													
Size	2	3	4	5	6	7	8	4	6	8	10	12	14	16
16	14.0	12.8*	12.1*	11.5*	11.3*	11.1*	11.0	12.0	11.1*	11.0*	10.5*	10.3*	10.0*	10.0
18	12.6*	11.6*	10.9*	10.4*	9.9*	9.5*	9.2*	10.9*	9.9*	9.2*	8.6*	8.2*	7.8*	7.5*
20	11.5*	10.5*	9.8*	9.2*	8.8*	8.4*	8.1*	9.8*	8.8*	8.1*	7.5*	7.0*	6.7*	6.3*
22	9.0	8.8*	8.6*	8.1*	7.6*	7.3*	7.0	8.0	7.6*	6.9*	6.4*	5.9*	5.5*	5.0

Temperature Rise vs. Current per EIA-364-70

Tested with UL1061 Tinned Wire and PCB with 2oz. Copper Traces of 1.8mm width and 3.5mm length. *Extrapolated from test data.

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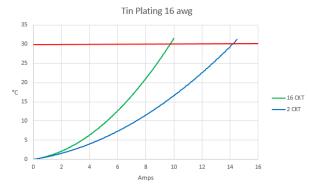
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Wire to Board Current Rating (Amp Max.) (Tested with GOLD plated terminals)														
	Connector fully loaded with all circuits powered													
AWG Wire		Ciı	cuit Si	ze (Sir	ngle Ro	ow)			С	ircuit S	Size (D	ual Ro	w)	
Size	2	3	4	5	6	7	8	4	6	8	10	12	14	16
16	12.0	11.2*	11.0*	10.7*	10.5*	10.3*	10.0	11.0	10.0*	9.2*	8.5*	8.0*	7.7*	7.0
18	11.0*	10.1*	9.5*	9.0*	8.6*	8.2*	7.9*	9.5*	8.6*	7.9*	7.4*	7.0*	6.6*	6.3*
20	10.0*	9.1*	8.4*	7.9*	7.5*	7.2*	6.9*	8.4*	7.5*	6.9*	6.4*	6.0*	5.6*	5.3*
22	8.0	7.7*	7.4*	6.9*	6.5*	6.1*	6.0	7.0	6.6*	6.0*	5.7*	5.4*	5.2*	5.0

Temperature Rise vs. Current per EIA-364-70

Tested with UL1061 Tinned Wire and PCB with 2oz. Copper Traces of 1.8mm width and 3.5mm length. *Extrapolated from test data.



4.4 **TEMPERATURE**

TIN plated

Max. operating temperature range (including T-rise from applied current) is -40°C to 105°C. Field temperatures and field life: Tested per EIA 364-1000.01 to meet field temperature of 65°C for 10 years life per table-8.

GOLD plated

Max. operating temperature range (including T-rise from applied current) is -40°C to 120°C, thermal aging at 120°C for 1000 hours.

Field temperatures and field life: Tested per EIA 364-1000.01 to meet field temperature of 85°C for 10 years or 95°C for 7 years life per table-8.

DURABILITY 4.5

Tin plated: 25 mating cycles Gold plated: 200 mating cycles

As tested in accordance with EIA-364-1000.01 test method (see Sec. 7.0 of this specification). Durability

per EIA-364-09



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4.6 GLOW WIRE

The following series are glow capacity: 172256, 172260, 172258 and 172262, some with TPA and 172286, 172287, 172298, 172299, 172310 and 172316. Representative samples were tested and found compliant with EN 60695-2-11-2001 / IEC 60695-2-11- 2000 Glow Wire Test Methods for End-Products. VDE Test report available upon request.

5.0 QUALIFICATION

Laboratory conditions and sample selection are in accordance with EIA-364-1000.01

6.0 PERFORMANCE

6.1 ELECTRICAL PERFORMANCE

DESCRIPTION	TEST CONDITION	REQUIREMENT
Initial Contact Resistance (Low Level)	Mate connectors, apply a maximum voltage of 20 mV and a current of 100 mA (measurement locations shown) Per EIA-364-23 Wire resistance and traces shall be removed from the measured value.	Maximum (Initial): Tin: 2 mΩ 15μ" & 30μ" Gold: 3 mΩ
Contact Resistance @Rated Current (Voltage Drop)	Mate connectors; apply the rated current. Per EIA-364-70	Maximum: Tin: 5 m Ω 15μ" & 30μ" Gold: 7 m Ω
Insulation Resistance	Apply 500 VDC between adjacent terminals or ground. Per EIA-364-21	1,000 M Ω minimum
Dielectric Withstanding Voltage	Apply 1800 VAC for 1 minute between adjacent terminals. Per EIA-364-20	No breakdown Current leakage <5mA
Temperature Rise	Mate connectors, measure T- Rise @ Rated Current Per EIA-364-70	Temperature rise: 30°C maximum (see chart) PASS



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6.2 MECHANICAL PERFORMANCE

ITEM	TEST CONDITION	REQUIREMENT
Connector Mating Force Without Latches	Mate connectors at a rate of 25.4 +/- 6 mm per minute. Per EIA-364- 37	Tin plated: 4.5 N MAX. initial mate force per circuit 15µ" & 30µ" Gold plated: 2.8 N MAX. per circuit
Connector Un-mating Force Without Latches	Un-mate connectors with latch disabled at a rate of 25.4 +/- 6 mm per minute. Per EIA-364-37	Tin plated: 4.0 N MAX. initial un-mate force per circuit 15µ" & 30µ" Gold plated: 2.3 N MAX. per circuit
Connector Mating Force Without Terminals	Mate connectors at a rate of 25.4 +/- 6 mm per minute. Per EIA-364- 37	8 N MAX.
Thumb Latch Yield Strength	Mate loaded connectors fully. Pull connectors apart at a rate of 25.4 +/- 6 mm per minute.	Locking tang option: 89 N MIN. Tangless option: 60 N MIN.
Durability	Mate connectors 25 cycles for tin plated and 200 cycles for gold plated connectors at a maximum rate of 10 cycles per minute. Per EIA-364-09	Maximum change from initial: Tin: 7 m Ω 15μ" & 30μ" Gold: 3 m Ω
Header Pin Retention Force in Housing	Axial pull force on the vertical header housing away from the PCB at a rate of 25.4 +/- 6 mm per minute.	Push from mating side: 50N MIN. Push from PCB side: 10N MIN.



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6.2 MECHANICAL PERFORMANCE (CONT.)						
ITEM	TEST CONDITION	REQUIREMENT				
PCB Peg Insertion Force into the PCB (Right Angle Header)	Insert a header at a rate of 25.4±6 mm/minute. (Applies to parts with PCB retention pegs only)	Header with 2 pegs: 35 N MAX insertion force Headers with 1 peg: 23 N MAX insertion force				
PCB Peg Retention Force to the PCB (Right Angle Header)	Insert a header at a rate of 25.4±6 mm/minute. (Applies to parts with PCB retention pegs only)	Header with 2 pegs: 0.2 N MIN retention force Headers with 1 peg: 0.1 N MIN retention force				
Header Insertion Force into the PCB (Vertical Header)	Insert a header at a rate of 25.4±6 mm/minute.	With Kinked Pins: 35 N MAX. With Solder Clip: 25 N MAX.				
Header Retention Force to the PCB (Vertical Header)	Remove a header at a rate of 25.4±6 mm/minute.	With Kinked Pins: 1 N MIN. With Solder Fork: 1 N MIN.				
Crimp Terminal Retention Force (in housing)	Axial pullout force on the terminal in the housing at a rate of 25 ± 6 mm per minute. Per EIA-364-29	27 N MINIMUM retention force				
Wire Pull Out Force From Terminal (Axial)	Apply an axial pullout force on the wire at a rate of 25 ± 6 mm per minute.	16AWG – 68.4N MIN 18AWG – 68.4N MIN 20AWG – 57.9N MIN 22AWG – 35.6N MIN Reference Molex Application Tooling Specification for Molex crimp tooling being used.				
Vibration (Random)	Mate connectors and vibrate per EIA-364-28 test condition VII-D Tin: 15 minutes each axis. Gold: 1.5 hours each axis.	Maximum Change from Initial: Tin: 7 m Ω 15μ" & 30μ" Gold: 3 m Ω Discontinuity < 1 microsecond				



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6.2 MECHANICAL PERFORMANCE (CONT.)						
ITEM ITEM		ITEM				
Vibration per USCAR-2 Class V1, S1, T2	Mate connectors, mounted and vibrate as per USCAR-2 Rev6: 5.4.6 Class V1, S1, T2. Random Duration: 8hrs/axis	Maximum Change from Initial: Tin: 7 mΩ 15μ" & 30μ" Gold: 3 mΩ				
Reseating	Unmate/Mate connectors by hand three cycles	Maximum Change from Initial: Tin: 7 m Ω 15μ" & 30μ" Gold: 3 m Ω				

6.3 ENVIRONMENTAL PERFORMANCE*

ITEM	TEST CONDITION	REQUIREMENT
Thermal Shock	Mate connectors, expose to 10 cycles from -55°C to 85°C Per EIA-364-32 method A, condition 1	Maximum Change from Initial: Tin: 7 mΩ 15μ" & 30μ" Gold: 3 mΩ
Thermal Aging	Tin Mate Connectors, expose to 240 hours at 105°C Per EIA-364-17 Method A Au 1,100 hours at 120°C	Maximum Change from Initial: Tin: 7 mΩ 15μ" & 30μ" Gold: 3 mΩ
Thermal Aging Precondition	Tin & Au 120hrs at 105°C Per EIA-364-17 method A	Maximum Change from Initial: Tin: 7 mΩ 15μ" & 30μ" Gold: 3 mΩ



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6.3 ENVIRONMENTAL PERFORMANCE* (CONT.)				
ITEM	TEST CONDITION	REQUIREMENT		
Cyclic Temperature And Humidity	Mate connectors: expose to 24 cycles from 25 °C / 80% RH to 65 °C / 50% RH ramp time: 0.5hr dwell time: 1hr Per EIA-364-31	Maximum Change from Initial: Tin: 7 m Ω 15μ" & 30μ" Gold: 3 m Ω		
Solderability Dip Test	Per Molex test method: SMES-152	Solder area shall have MIN. of 95% solder coverage (PASS)		
Reflow Solder Resistance	Convection reflow solder process 260°C Max per AS-40000-5013	Visual: No damage		
Wave Solder Resistance	Dip header terminal tails in solder: Duration: 5±0.5 seconds Solder temperature: 260±5° C Per AS-40000-5013	Visual: No damage		
Thermal Cycling Tin Plated Only	Per EIA-364-1000.01 Test Group 5: Cycle mated connector between 15°C±3°C and 85°C±3°C as measured on the part. Ramps should be a minimum of 2°C per minute, and dwell times should insure contacts reach the temperature extremes (minimum of 5 minutes). Humidity is not controlled. Perform 500 cycles.	Maximum Change from Initial: Tin: 7 mΩ		

^{*}Environmental tests have been performed per EIA-364-100.01 except where noted.



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7.0 TEST SEQUENCE GROUPS Reliability Test Sequences Per 364-1000.01 Group I Group II **Group III Group V Group VII** Temperature Life Thermal Shock Vibration Thermal Cycling Durability 144 contacts tin 144 contacts gold 144 contacts gold 144 contacts gold (tin plated only) 144 contacts gold **Initial Contact Initial Contact Initial Contact Initial Contact** DWV Resistance Resistance Resistance Resistance EIA-364-20 EIA-364-23 EIA-364-23 EIA-364-23 EIA-364-23 Durability Durability Durability Tin plated: 5 cycles Tin plated: 5 cycles Durability Tin plated: 5 cycles **Initial Contact** Gold plated: 20 Gold plated: 20 5 cycles Gold plated: 20 Resistance cycles cycles EIA-364-09 cycles EIA-364-23 EIA-364-09 EIA-364-09 EIA-364-09 Contact Resistance Contact Resistance Contact Resistance Contact Resistance Durability Thermal Aging Tin plated: 25 TIN 105°C, 240 hrs Thermal Aging Thermal Aging Thermal Shock cycles Pre-condition Pre-condition (10 Yrs @ 65°C) 10 cycles Gold plated: 200 105°C, 120 hours 105°C, 120 hours EIA-364-17 -55°C and +85°C cycles 10 Yrs @ 65°C GOLD 120°C, 1000 10 Yrs @ 65°C EIA-364-32 EIA-364-09 EIA-364-17 EIA-364-17 hrs Contact Contact Resistance Contact Resistance Contact Resistance Contact Resistance Resistance Cyclic Temperature Random Vibration Thermal Cycling DWV Reseating and Humidity EIA-364-28 EIA-364-1000.01 3 cycles EIA-364-20 EIA-364-31 Condition VIID Contact Resistance | Contact Resistance Contact Resistance Contact Resistance Latch Retention Reseating Reseating 3 cycles 3 cycles Contact Resistance Contact Resistance

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Individual Tests

Connector Mating / Unmating Force

Connector

Mating / Unmating with latch without terminals

Header Pin Retention Force in the Housina

Header Insertion/Retention into the PCB (Vertical Header with kinked pins 16 circuit, PTH)

Header Insertion/Retention into the PCB (Vertical Header with solder clip)

R/A Header Insertion/Retention into the PCB (crush pegs)

Receptacle Terminal retention force into the housing 20 Terminals / 4 Connectors

Crimped terminal retention force into the housing with TPA

Solderability Dip Test

Solder Clip retention force into the housing

Receptacle latch retention force

Receptacle latch retention force after durability x200 cycles

USCAR Vibration

Initial Contact Resistance USCAR 5.9.6 Class V1, S1, T2

Connector and/or Terminal Cvclina USCAR-2 Rev6: 5.1.7

Voltage Drop USCAR-2 Rev6: 5.3.2

Vibration USCAR-2 Rev6: 5.4.6

Mechanical Shock USCAR-2 Rev6: 5.4.6

Dry Circuit Resistance

MOLEX ULTRA-FIT WEB PAGE

REVISION: ECR/ECN INFORMATION: TITLE: PRODUCT SPECIFICATION FOR ULTRA-FIT EC No: 636692 В **CONNECTOR SYSTEM** DATE: 04/29/2020

15 of **23**

DOCUMENT NUMBER:

PS-172323-0001

CREATED / REVISED BY:

STORM.CHEN

CHECKED BY:

APPROVED BY:

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JONNY.ZHENG ANSON.YIN



8.0 SOLDER INFORMATION

Molex Solderability Specification SMES-152 (Click Here)

8.1 SOLDER PROCESS TEMPERATURES

Wave Solder: 265°C Max Reflow Solder: 260°C Max

8.2 REFLOW SOLDERING PROFILE

(This profile is per AS-40000-5013 and is provided as a guideline only. Please see notes for additional information)

Molex Connector Heat Resistance
Specification AS-40000-5013
(Click Here)

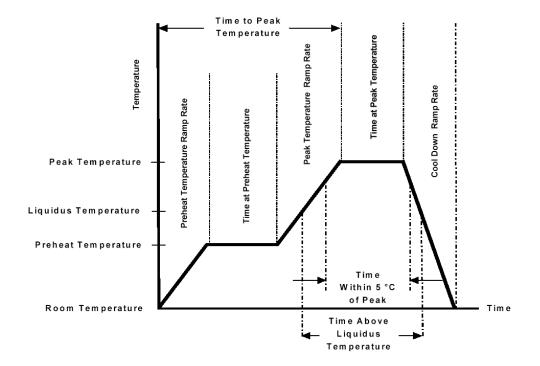




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Description	Requirement
Average Ramp Rate	3°C/sec Max
Preheat Temperature	150°C Min to 200°C Max
Preheat Time	60 to 180 sec
Ramp to Peak	3°C/sec Max
Time over Liquidus (217°C)	60 to 150 sec
Peak Temperature	260 +0/-5°C
Time within 5°C of Peak	20 to 40 sec
Ramp - Cool Down	6°C/sec Max
Time 25°C to Peak	8 min Max

Notes:

- 1. Temperature indicated refers to the PCB surface temperature at solder tail area.
- 2. Connector can withstand 1 reflow cycle.
- 3. Actual reflow profile also depends on equipment, solder paste, PCB thickness, and other components on the board. Please consult your solder paste & reflow equipment manufacturer for their recommendations to adopt a suitable process.

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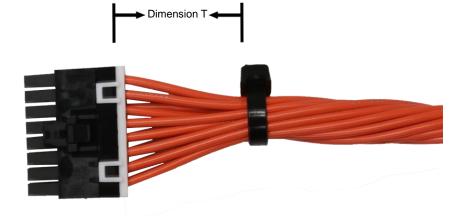


9.0 PACKAGING

Parts shall be packaged to protect against damage during normal handling, transit and storage. Refer Molex.com specific part number webpage to get the exact packaging document for that item.

10.0 CABLE TIE AND/OR WIRE TWIST LOCATION

Circuit Sizes		es	Dimension T Minimum
2	4	6	0.50" (12.7mm)
	8		0.75" (19.1mm)
10		12	1.00" (25.40mm)
14		16	1.25" (31.75mm)
18		20	1.50" (38.09mm)
22		24	1.75" (44.45mm)



The "T" dimension defines a "free" length of wire, or a length of wire that is not subject to significant bias by external factors such as a wire tie, wire twisting, or other means of bending or deforming of the wires that repositions them from their natural relaxed state or location where they enter the housing. Wires are to be dressed in such a manner to allow the terminals to float freely in the pocket. This dimension is general recommendation and may need to be adjusted for different wire gauges and wire type and insulation thickness and insulation material.

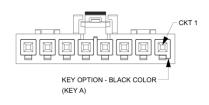


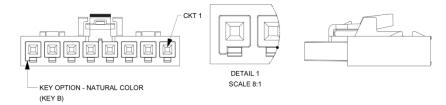
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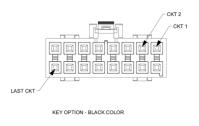
11.0 POLARIZATION AND KEYING OPTIONS

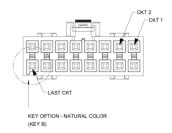
11.1 Single Row Receptacle (Series: 172256)



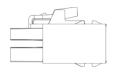


11.2 Dual Row Receptacle (Series: 172258)

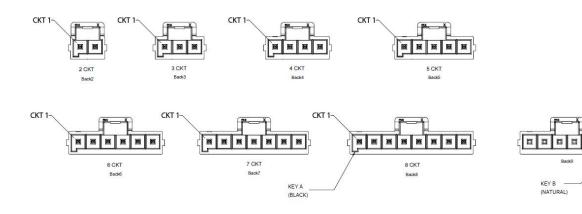








11.3 Vertical Header Single Row Kinked Pins (Series: 172286)



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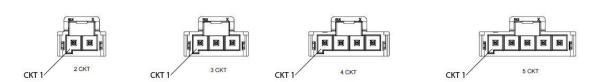


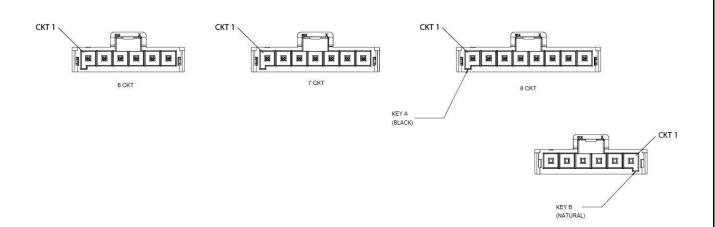
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11.4 Vertical Header Single Row Solder Clip (Series: 172287)





11.5 Vertical Header Dual Row Kinked Pins (Series: 172298)

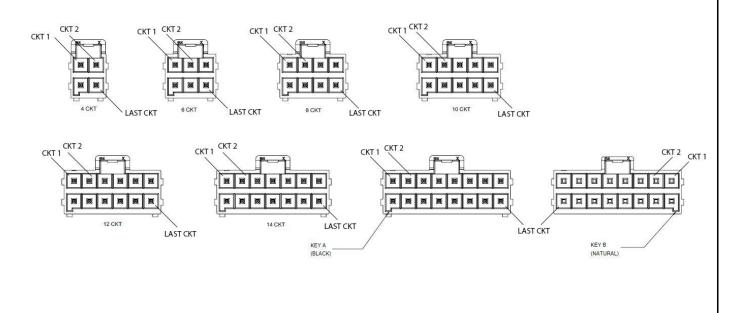
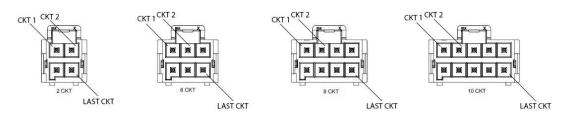


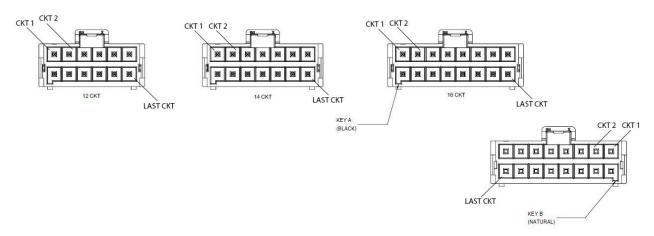
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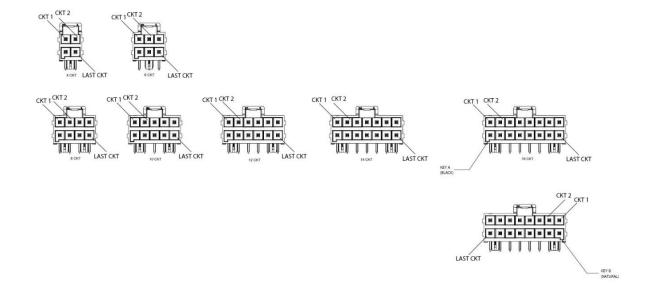


11.6 Vertical Header Dual Row Solder Clip (Series: 172299)





11.7 Right Angle Header Dual Row (Series: 172316)





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11.9 Right Angle Header Dual Row Solder Nail (Series: 172316)

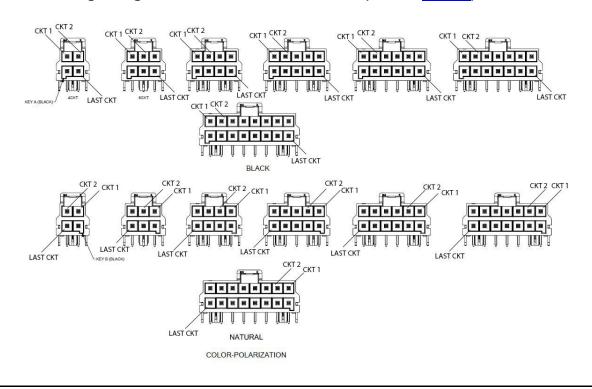
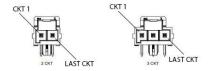


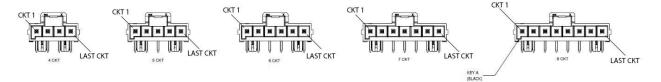


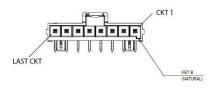
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11.10 Right Angle Header Single Row Solder Nail (Series: 172310)

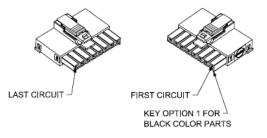


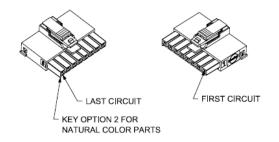




11.11 Tangless Receptacle Housing Single Row (Series: 172256)

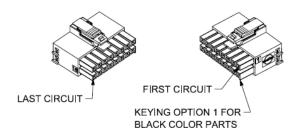
KEY OPTION 1 KEY OPTION 2

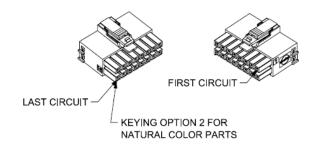




11.12 Tangless Receptacle Dual Row Housing (Series: 172258)

KEYING OPTION 2 KEYING OPTION 1





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